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## 1. Product profile

### 1.1 General description

10 W LDMOS power transistor for base station applications at frequencies from HF to 2200 MHz

**Table 1. Typical performance**

$I_{DQ} = 100 \text{ mA}$ ;  $T_{case} = 25 \text{ }^\circ\text{C}$  in a common source class-AB production test circuit.

| Mode of operation | f (MHz)      | V <sub>DS</sub> (V) | P <sub>L(AV)</sub> (W) | G <sub>p</sub> (dB) | $\eta_D$ (%) | ACPR (dBc)         |
|-------------------|--------------|---------------------|------------------------|---------------------|--------------|--------------------|
| 2-carrier W-CDMA  | 2110 to 2170 | 28                  | 0.7                    | 18.5                | 15           | -50 <sup>[1]</sup> |
| 1-carrier W-CDMA  | 2110 to 2170 | 28                  | 2                      | 19.3                | 31           | -39 <sup>[1]</sup> |

[1] Test signal: 3GPP; test model 1; 64 DPCH; PAR = 7.5 dB at 0.01 % probability on CCDF per carrier; carrier spacing 5 MHz.

### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

### 1.2 Features and benefits

- Typical 2-carrier W-CDMA performance at frequencies of 2110 MHz and 2170 MHz, a supply voltage of 28 V and an  $I_{DQ}$  of 100 mA:
  - ◆ Average output power = 0.7 W
  - ◆ Gain = 18.5 dB
  - ◆ Efficiency = 15 %
  - ◆ ACPR = -50 dBc
- Typical 1-carrier W-CDMA performance at frequencies of 2110 MHz and 2170 MHz, a supply voltage of 28 V and an  $I_{DQ}$  of 100 mA:
  - ◆ Average output power = 2 W
  - ◆ Gain = 19.3 dB
  - ◆ Efficiency = 31 %
  - ◆ ACPR = -39 dBc
- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency

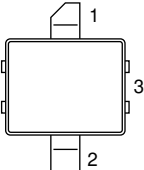
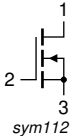
- Excellent thermal stability
- No internal matching for broadband operation
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

### 1.3 Applications

- RF power amplifiers for GSM, PHS, EDGE, CDMA and W-CDMA base stations and multi carrier applications in the HF to 2200 MHz frequency range
- Broadcast drivers

## 2. Pinning information

Table 2. Pinning

| Pin | Description | Simplified outline  | Graphic symbol  |
|-----|-------------|---|---|
| 1   | drain       |  |  |
| 2   | gate        |   |   |
| 3   | source      |   |   |

[1] Connected to flange.

## 3. Ordering information

Table 3. Ordering information

| Type number | Package |  |         |
|-------------|---------|--|---------|
|             | Name    | Description                              | Version |
| BLF6G21-10G | -       | ceramic surface-mounted package; 2 leads | SOT538A |

## 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol    | Parameter            | Conditions | Min  | Max  | Unit |
|-----------|----------------------|------------|------|------|------|
| $V_{DS}$  | drain-source voltage |            | -    | 65   | V    |
| $V_{GS}$  | gate-source voltage  |            | -0.5 | +13  | V    |
| $T_{stg}$ | storage temperature  |            | -65  | +150 | °C   |
| $T_j$     | junction temperature |            | -    | 225  | °C   |

## 5. Thermal characteristics

**Table 5. Thermal characteristics**

| Symbol           | Parameter                                | Conditions   | Typ | Unit |
|------------------|--|--|-----|------|
| $R_{th(j-case)}$ | thermal resistance from junction to case | $T_{case} = 80\text{ °C}; P_{L(AV)} = 11\text{ W}$ | 3.2 | K/W  |

[1] Thermal resistance is determined under specified RF operating conditions

## 6. Characteristics

**Table 6. Characteristics**

$T_j = 25\text{ °C}$  unless otherwise specified

| Symbol        | Parameter                        | Conditions  | Min | Typ | Max | Unit          |
|---------------|----------------------------------|---|-----|-----|-----|---------------|
| $V_{(BR)DSS}$ | drain-source breakdown voltage   | $V_{GS} = 0\text{ V}; I_D = 0.5\text{ mA}$                    | 65  | -   | -   | V             |
| $V_{GS(th)}$  | gate-source threshold voltage    | $V_{DS} = 10\text{ V}; I_D = 18\text{ mA}$                    | 1.4 | 1.9 | 2.4 | V             |
| $I_{DSS}$     | drain leakage current            | $V_{GS} = 0\text{ V}; V_{DS} = 28\text{ V}$                   | -   | -   | 1.5 | $\mu\text{A}$ |
| $I_{DSX}$     | drain cut-off current            | $V_{GS} = V_{GS(th)} + 3.75\text{ V}; V_{DS} = 10\text{ V}$   | -   | 3.1 | -   | A             |
| $I_{GSS}$     | gate leakage current             | $V_{GS} = 11\text{ V}; V_{DS} = 0\text{ V}$                   | -   | -   | 150 | nA            |
| $g_{fs}$      | forward transconductance         | $V_{DS} = 10\text{ V}; I_D = 0.9\text{ A}$                    | -   | 0.5 | -   | S             |
| $R_{DS(on)}$  | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 3.75\text{ V}; I_D = 0.625\text{ A}$   | -   | 0.4 | -   | $\Omega$      |
| $C_{fs}$      | feedback capacitance             | $V_{GS} = 0\text{ V}; V_{DS} = 28\text{ V}; f = 1\text{ MHz}$ | -   | 0.5 | -   | pF            |

## 7. Application information

**Table 7. Application information**

Mode of operation: 2-carrier W-CDMA; PAR 7.5 dB at 0.01 % probability on CCDF; 3GPP test model 1; 1-64 PDPCH;  $f_1 = 2112.5\text{ MHz}; f_2 = 2117.5\text{ MHz}; f_3 = 2162.5\text{ MHz}; f_4 = 2167.5\text{ MHz}$ ; RF performance at  $V_{DS} = 28\text{ V}; I_{Dq} = 100\text{ mA}; T_{case} = 25\text{ °C}$ ; unless otherwise specified; in a class-AB production test circuit.

| Symbol   | Parameter                    | Conditions                 | Min | Typ  | Max | Unit |
|----------|------------------------------|----------------------------|-----|------|-----|------|
| $G_p$    | power gain                   | $P_{L(AV)} = 0.7\text{ W}$ | -   | 18.5 | -   | dB   |
| $\eta_D$ | drain efficiency             | $P_{L(AV)} = 0.7\text{ W}$ | -   | 15   | -   | %    |
| ACPR     | adjacent channel power ratio | $P_{L(AV)} = 0.7\text{ W}$ | -   | -50  | -   | dBc  |

**Table 8. Application information**

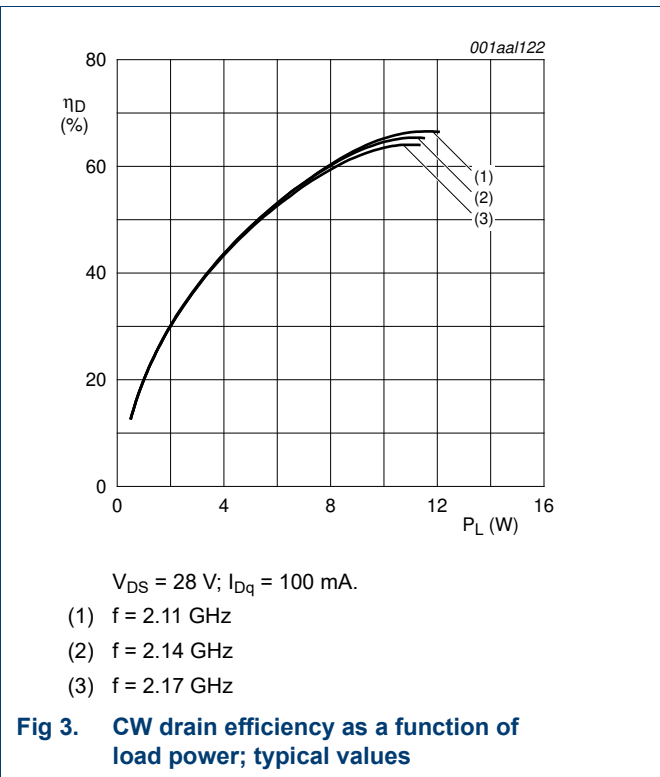
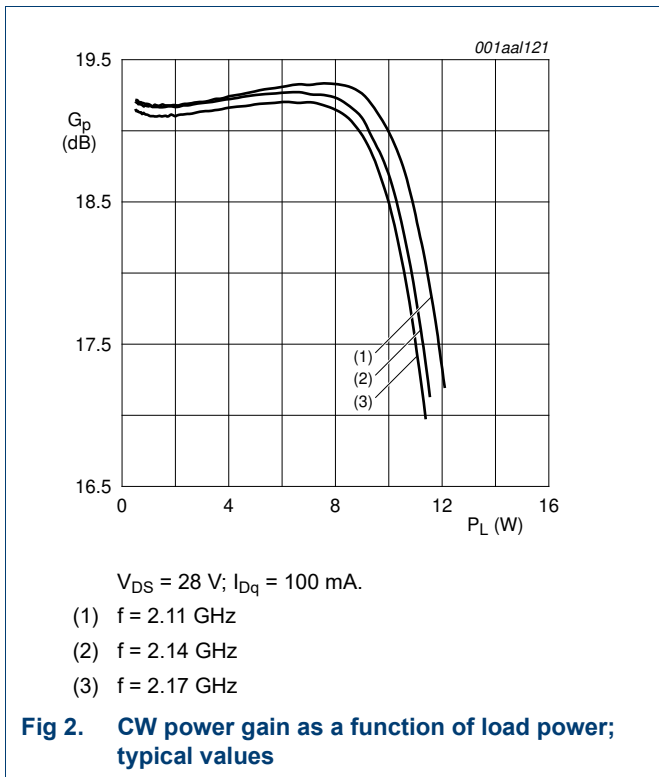
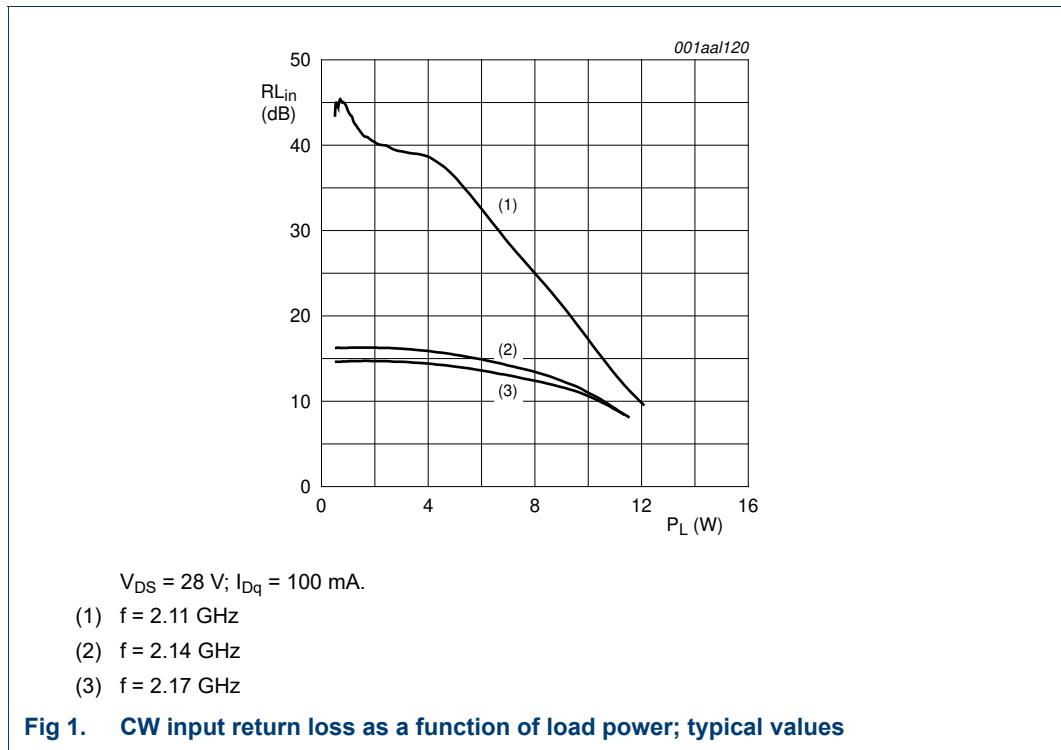
Mode of operation: 1-carrier W-CDMA; PAR 7.5 dB at 0.01 % probability on CCDF; 3GPP test model 1; 1-64 PDPCH;  $f_1 = 2112.5\text{ MHz}; f_2 = 2167.5\text{ MHz}$ ; RF performance at  $V_{DS} = 28\text{ V}; I_{Dq} = 100\text{ mA}; T_{case} = 25\text{ °C}$ ; unless otherwise specified; in a class-AB production test circuit.

| Symbol   | Parameter                    | Conditions               | Min  | Typ  | Max | Unit |
|----------|------------------------------|--------------------------|------|------|-----|------|
| $G_p$    | power gain                   | $P_{L(AV)} = 2\text{ W}$ | 17.3 | 19.3 | -   | dB   |
| $\eta_D$ | drain efficiency             | $P_{L(AV)} = 2\text{ W}$ | 29   | 31   | -   | %    |
| ACPR     | adjacent channel power ratio | $P_{L(AV)} = 2\text{ W}$ | -    | -39  | -36 | dBc  |

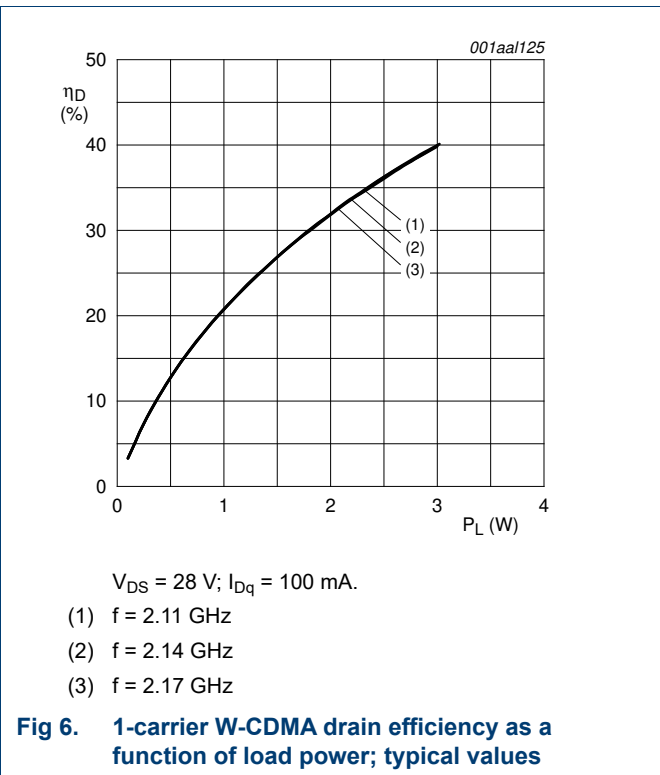
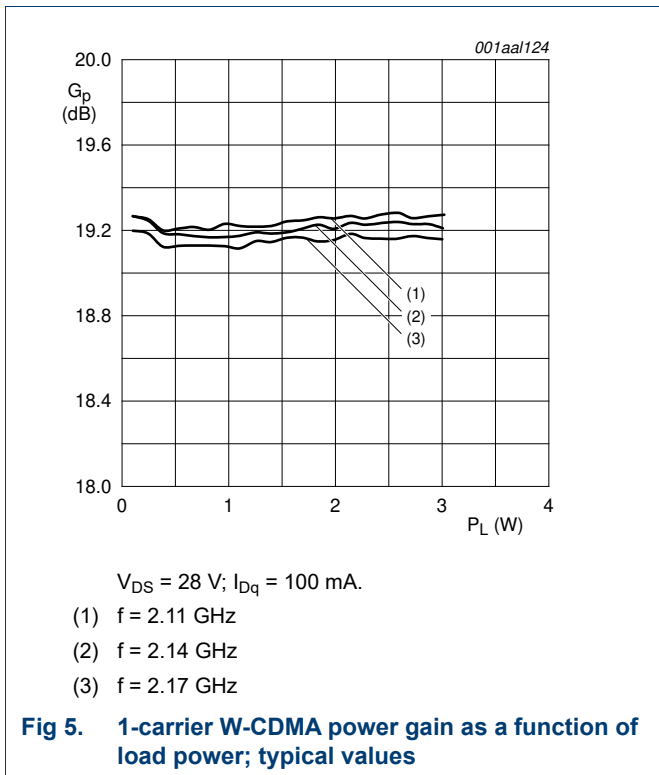
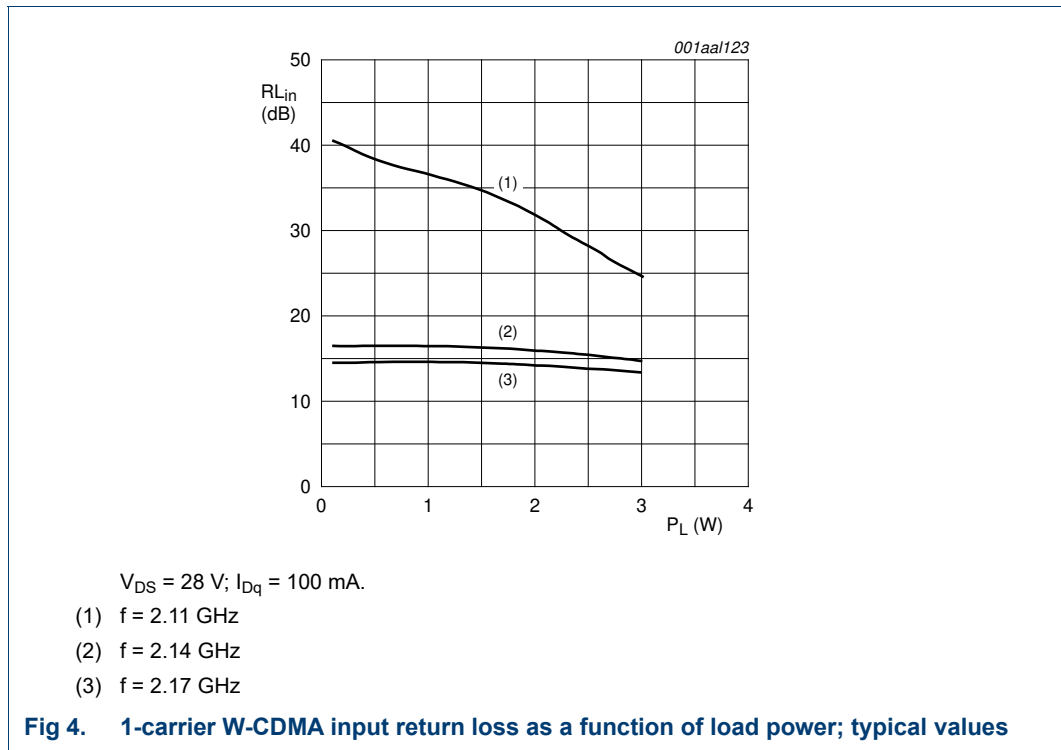
### 7.1 Ruggedness in class-AB operation

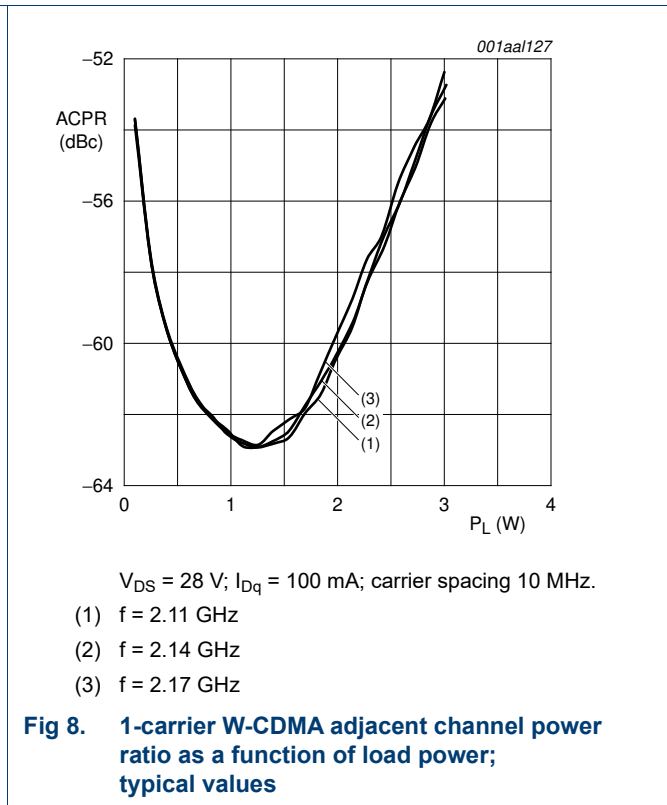
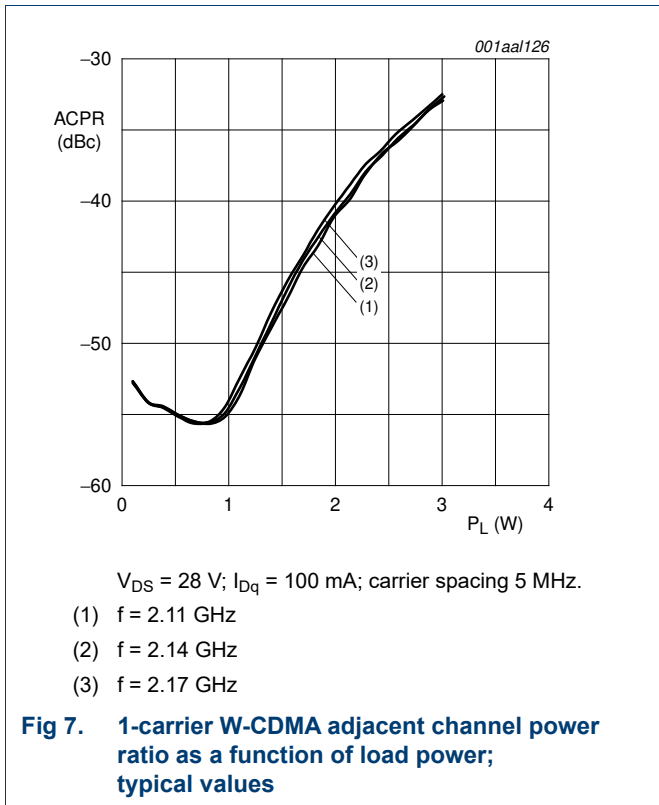
The BLF6G21-10G is capable of withstanding a load mismatch corresponding to  $VSWR = 10 : 1$  through all phases under the following conditions:  $V_{DS} = 28\text{ V}; f = 2140\text{ MHz}$  at  $P_L = 10\text{ W}$ .

7.2 CW

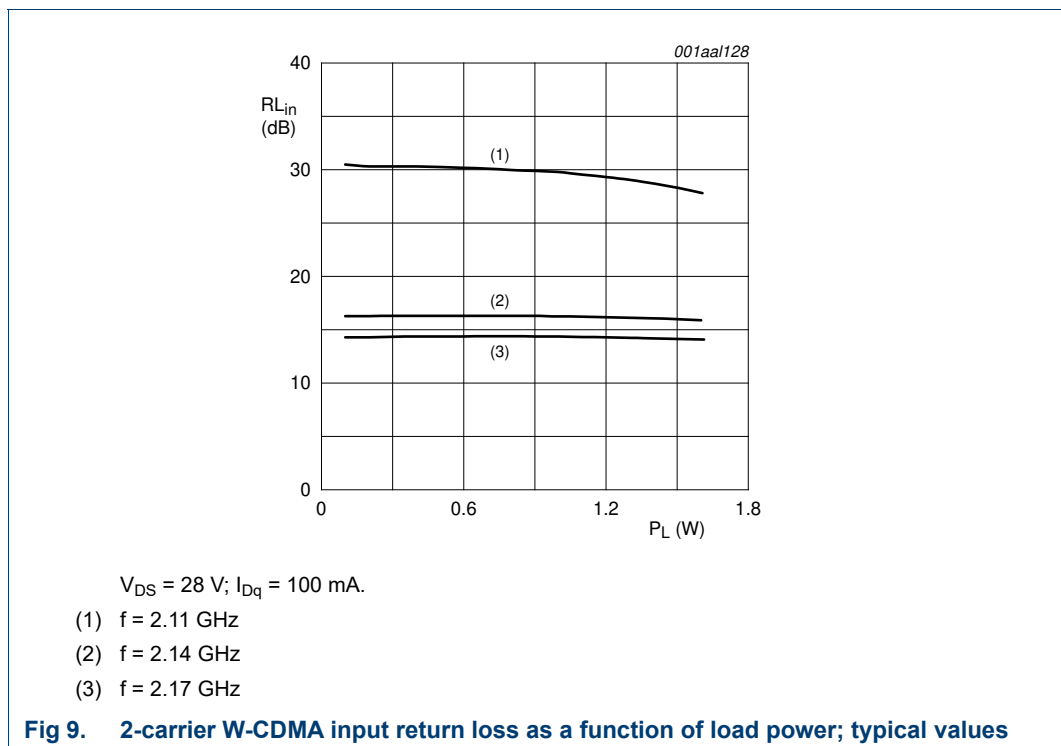


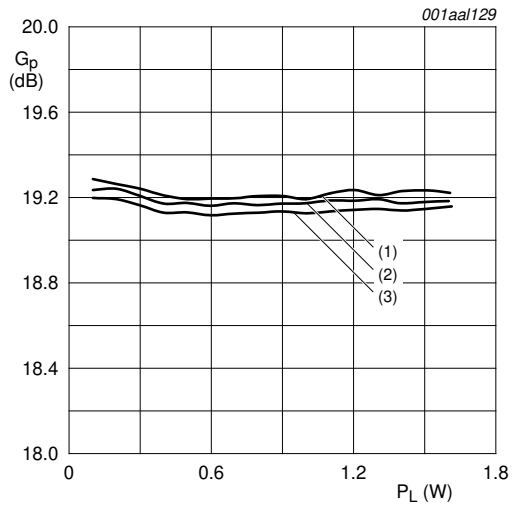
7.3 1-carrier W-CDMA





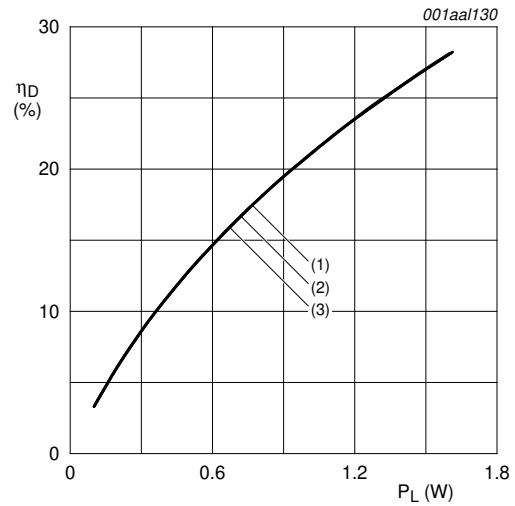
### 7.4 2-carrier W-CDMA





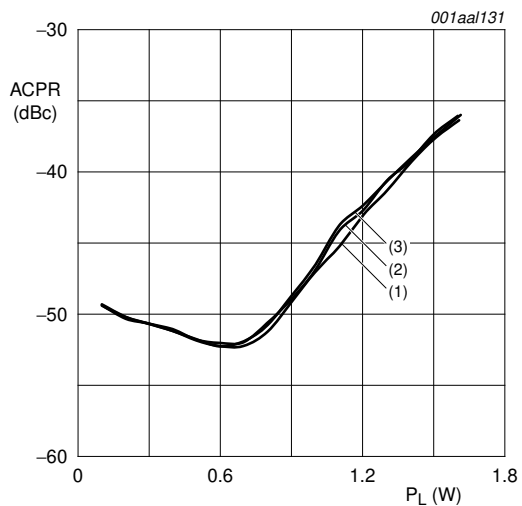
$V_{DS} = 28\text{ V}; I_{Dq} = 100\text{ mA}.$   
 (1)  $f = 2.11\text{ GHz}$   
 (2)  $f = 2.14\text{ GHz}$   
 (3)  $f = 2.17\text{ GHz}$

**Fig 10. 2-carrier W-CDMA power gain as a function of load power; typical values**



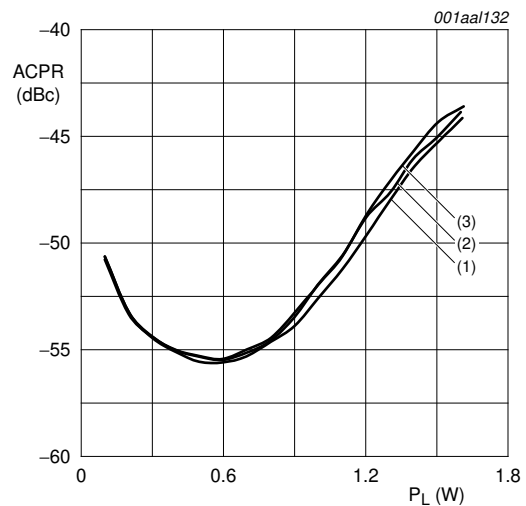
$V_{DS} = 28\text{ V}; I_{Dq} = 100\text{ mA}.$   
 (1)  $f = 2.11\text{ GHz}$   
 (2)  $f = 2.14\text{ GHz}$   
 (3)  $f = 2.17\text{ GHz}$

**Fig 11. 2-carrier W-CDMA drain efficiency as a function of load power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 100\text{ mA};$  carrier spacing 5 MHz.  
 (1)  $f = 2.11\text{ GHz}$   
 (2)  $f = 2.14\text{ GHz}$   
 (3)  $f = 2.17\text{ GHz}$

**Fig 12. 2-carrier W-CDMA adjacent channel power ratio as a function of load power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 100\text{ mA};$  carrier spacing 10 MHz.  
 (1)  $f = 2.11\text{ GHz}$   
 (2)  $f = 2.14\text{ GHz}$   
 (3)  $f = 2.17\text{ GHz}$

**Fig 13. 2-carrier W-CDMA adjacent channel power ratio as a function of load power; typical values**



### 8. Package outline

Ceramic surface-mounted package; 2 leads

SOT538A

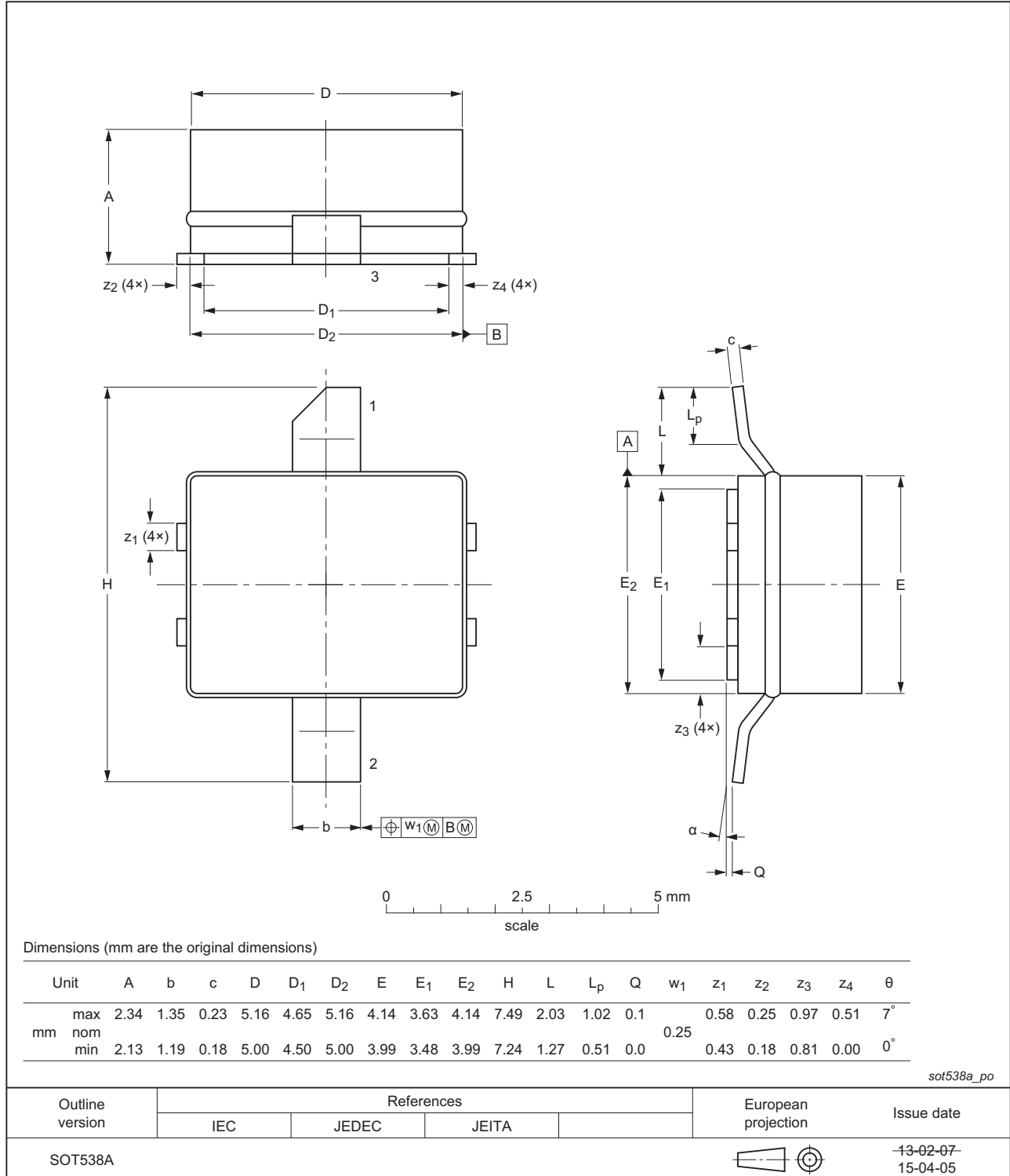


Fig 14. Package outline SOT538A

## 9. Abbreviations

Table 9. Abbreviations

| Acronym | Description  |
|---------|--|
| 3GPP    | Third Generation Partnership Project                 |
| CCDF    | Complementary Cumulative Distribution Function       |
| CDMA    | Code Division Multiple Access                        |
| CW      | Continuous Wave                                      |
| DPCH    | Dedicated Physical CHannel                           |
| EDGE    | Enhanced Data rates for GSM Evolution                |
| GSM     | Global System for Mobile communications              |
| HF      | High Frequency                                       |
| LDMOS   | Laterally Diffused Metal Oxide Semiconductor         |
| PAR     | Peak-to-Average power Ratio                          |
| PDPCH   | transmission Power of the Dedicated Physical CHannel |
| PHS     | Personal Handy-phone System                          |
| RF      | Radio Frequency                                      |
| VSWR    | Voltage Standing Wave Ratio                          |
| W-CDMA  | Wideband Code Division Multiple Access               |

## 10. Revision history

Table 10. Revision history

| Document ID     | Release date   | Data sheet status    | Change notice | Supersedes      |
|-----------------|--|----------------------|---------------|-----------------|
| BLF6G21-10G#4   | 20150901   | Product data sheet   | -             | BLF6G21-10G v.3 |
| Modifications:  | <ul style="list-style-type: none"> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul> |                      |               |                 |
| BLF6G21-10G v.3 | 20130411   | Product data sheet   | -             | BLF6G21-10G v.2 |
| BLF6G21-10G v.2 | 20091211   | Product data sheet   | -             | BLF6G21-10G v.1 |
| BLF6G21-10G v.1 | 20090511   | Objective data sheet | -             | -               |

## 11. Legal information

### 11.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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